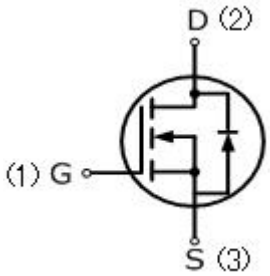
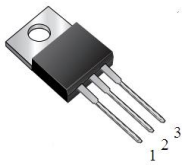
75N08(F,B,H)

75A mps,80 Volts N-CHANNEL MOSFET

FEATURE

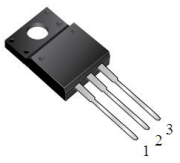
- 75A,80V,$R_{DS(ON)}$=17mΩ@V_{GS}=10V/35A
- Low gate charge
- Low C_{iss}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability





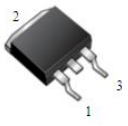
TO-220AB

75N08



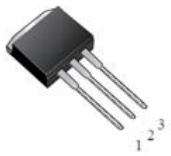
ITO-220AB

75N08F



TO-263

75N08B



TO-262

75N08H

Absolute Maximum Ratings(T_C=25℃,unless otherwise noted)

Parameter		Symbol	75N08	UNIT
Drain-Source Voltage		V_{DSS}	80	V
Gate-Source Voltage		V_{GSS}	±20	
Continuous Drain Current		I_D	75	A
Pulsed Drain Current(Note1)		I_{DM}	300	
Single Pulse Avalanche Energy (Note 2)		E_{AS}	1550	mJ
Avalanche Current(Note1)		I_{AR}	70	A
Repetitive Avalanche Energy (Note1)		E_{AR}	15.5	mJ
Reverse Diode dV/dt (Note 3)		dv/dt	7.0	V/ns
Operating Junction and Storage Temperature Range		T_J,T_{STG}	-55 to +150	℃
Maximum lead temperature for soldering purposes, 1/8″from case for 5 seconds		T_L	260	℃
Mounting Torque	6-32 or M3 screw		10	lbf • in
			1.1	N • m

Thermal Characteristics

Parameter		Symbol	ITO-220	TO-220	TO-262 TO-263	Units
Maximum Junction-to-Case		R_{thJC}	1.6	0.8	0.8	℃/W
Maximum Power Dissipation	T_C=25℃	P_D	78	156	156	W

Electrical Characteristics (T_c=25℃,unless otherwise noted)						
Parameter	**Symbol**	**Test Conditions**	**Mix**	**Typ**	**Max**	**Units**
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V,I_D=250uA	80	—	—	V
Breakdown Temperature Coefficient	ΔBV_{DSS} /ΔT_J	Reference to 25℃, I_D=250uA	—	0.08	—	V/℃
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=80V,V_{GS}=0V	—	—	1	uA
Gate-Body Leakage Current,Forward	I_{GSSF}	V_{GS}=20V,V_{DS}=0V	—	—	100	nA
Gate-Body Leakage Current,Reverse	I_{GSSR}	V_{GS}=-20V,V_{DS}=0V	—	—	-100	nA
On Characteristics						
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS}=10V,I_D=250uA	2.0	—	4.0	V
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS}=10V,I_D=35A	—	—	17	mΩ
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{DS}=25V,V_{GS}=0V, f=1.0MHZ	—	2100	2700	pF
Output Capacitance	C_{oss}		—	790	1030	pF
Reverse Transfer Capacitance	C_{rss}		—	180	230	pF
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	V_{DD}=40V,I_D=75A, R_G=25Ω (Note4,5)	—	25	60	ns
Turn-On Rise Time	t_r		—	300	610	ns
Turn-Off Delay Time	$t_{d(off)}$		—	90	190	ns
Turn-Off Fall Time	t_f		—	145	300	ns
Total Gate Charge	Qg	V_{DS}=60V,I_D=75A, V_{GS}=10V, (Note4,5)	—	75	98	nC
Gate-Source Charge	Qgs		—	14	—	nC
Gate-Drain Charge	Qgd		—	37	—	nC
Drain-Source Body Diode Charcteristics and Maximum Ratings						
Continuous Diode Forward Current	I_S		—	—	75	A
Pulsed Diode Forward Current	I_{SM}		—	—	300	A
Diode Forward Voltage	V_{SD}	I_S=75A,V_{GS}=0V	—	—	1.5	V
Reverse Recovery Time	t_{rr}	V_{GS}=0V,I_S=75A, dI_F/dt=100A/us, (Note4)	—	84	—	ns
Reverse Recovery Charge	Q_{rr}		—	250	—	uC

Notes

1. Repetitive Rating:pulse width limited by maximum junction temperature.
2. V_{DD}=20V,starling,L=0.4mH,R_g=25Ω,I_{AS}=75A , T_J=25℃.
3. I_{SD}≤I_D,dI/dt=_A/us,V_{DD}≤BV_{DSS},starting T_J=25℃.
4. Pulse width≤300us;duty cycle≤2%.
5. Repetitive rating; pulse width limited by maximum junction temperature.